

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yimin Wang	01/07/2011
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13008252
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Total Attachments: 2 source=N1161-00040Assignment#page1.tif source=N1161-00040Assignment#page2.tif	

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REEL: 025653 FRAME: 0715

ASSIGNMENT

I, **Yimin Wang** of 3404 NW 9th Ave., Camas, WA 98607, hereby declare that I am the sole inventor of the invention entitled **METHODS AND STRUCTURES FOR CUSTOMIZED STI STRUCTURES IN SEMICONDUCTOR DEVICES** described in non-provisional **U.S. Patent Application** as filed herewith.

For valuable consideration received, I hereby sell, assign, and transfer to **WaferTech, LLC**, a Corporation, with its principal place of business located at 5509 N.W. Parker Street, Camas, WA 98607, duly organized and existing under the laws of the United States of America, its successors, and assigns, my entire right, title, and interest, for all countries in and to said applications, said inventions, and all the rights and privileges under any and all applications and Letters Patents that may be granted therefore, and any divisions, continuations-in-part, reexaminations, continuations, reissues, and extensions, and all national stage applications thereof, and all other U.S. and foreign patent applications claiming priority therefrom.

I agree that, when requested, I will, without charge to said Corporation but at its expense, sign all papers, take all rightful oaths, make all rightful declarations, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents or other forms of protection for said inventions in any and all countries, and for vesting title thereto in said Corporation, its successors, assigns or nominees.

I agree that I will communicate to said Corporation or its representatives any facts known to me respecting said inventions and, when requested by said Corporation and at its expense, will testify in any legal proceedings, and generally do everything possible to aid said Corporation, its successors, assigns, and legal representatives or nominees, to obtain or enforce proper protection for said inventions in any and all countries.

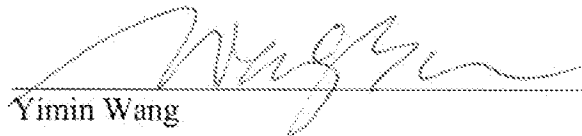
I authorize and empower said Corporation, its successors, assigns or nominees, to make application for patent or other form of protection for said inventions in its or their own name, or in our names, in any and all countries, and to invoke and claim for any application for patent or other form of protection for said inventions filed by it or them, the benefit of the right or priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it, and to invoke and claim such right of priority without further written or oral authorization from me.

I hereby consent that a copy of this Assignment shall be deemed a full, legal, and formal equivalent of any Assignment, consent to file or like document, which may be required in any country for any purpose, and more particularly, in proof of the right of the said Corporation or its

successors, assigns or nominees to apply for patent or other proper protection for said inventions, and to claim the aforesaid benefits of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it.

I covenant with said corporation, its successors, assigns, legal representatives, and nominees, that to the best of my knowledge the right, title, and interest herein conveyed by me, are free and clear of any encumbrance, and that we have full right to convey the same as herein expressed.

Dated: 01/07/2011


Yimin Wang